Taiwan Semiconductor

1.5A, 600V - 1000V Standard Bridge Rectifier

FEATURES

TAIWAN

• AEC-Q101 qualified available

SEMICONDUCTOR

- Glass passivated chip junction
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

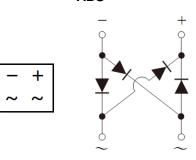
MECHANICAL DATA

- Case: ABS
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.096g (approximately)

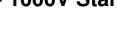
KEY PARAMETERS				
PARAMETER VALUE U				
١ _F	1.5	А		
V _{RRM}	600 - 1000	V		
I _{FSM}	40	А		
T _{J MAX}	150	°C		
Package	ABS			
Configuration	Quad			







ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
PARAMETER		SYMBOL	ABS15J	ABS15M	UNIT	
Marking code on the	device			ABS15J	ABS15M	
Repetitive peak reve	erse voltag	е	V _{RRM}	600	1000	V
Reverse voltage, tot	Reverse voltage, total rms value		$V_{R(RMS)}$	420	700	V
Forward current	On glass-			1.5		А
Forward current	On aluminum substrate		I _F	2.	0	А
single half sinewave		t = 8.3ms	1	40		А
		t = 1.0ms	FSM	100		А
Rating for fusing (t<8.3ms)		l ² t	6.64		A ² s	
Junction temperature		TJ	- 55 to +150		°C	
Storage temperature		T _{STG}	- 55 to +150		°C	





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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	ТҮР	UNIT		
Junction-to-lead thermal resistance	$R_{\Theta JL}$	25	°C/W		
Junction-to-ambient thermal resistance	R _{eja}	80	°C/W		

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 0.5A, T_J = 25^{\circ}C$	V _F	0.88	-	V
	$I_F = 1.5A, T_J = 25^{\circ}C$		0.97	1.00	V
Reverse current @ rated V_R per diode ⁽²⁾	$T_J = 25^{\circ}C$	- I _R	-	5	μA
neverse current @ rated v _R per diode	T _J = 125°C		-	150	μA

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING		
ABS15x	ABS	5,000 / Tape & Reel		
ABS15xH	ABS	5,000 / Tape & Reel		

Notes:

1. "x" defines voltage from 600V(ABS15J) to 1000V(ABS15M)

2. "H" means AEC-Q101 qualified



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

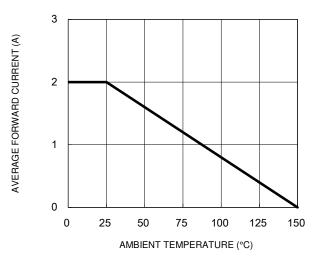


Fig.3 Typical Reverse Characteristics

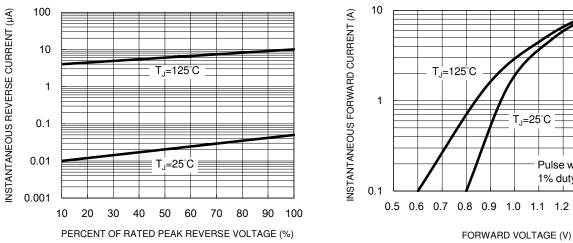


Fig.1 Forward Current Derating Curve

1000 CAPACITANCE (pF) 100 10 f=1.0MHz Vsig=50mVp-p 1 10 100 0.1 1 REVERSE VOLTAGE (V)

Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics

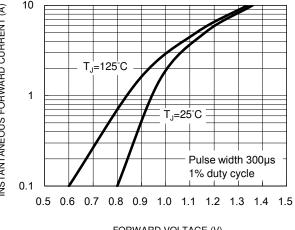
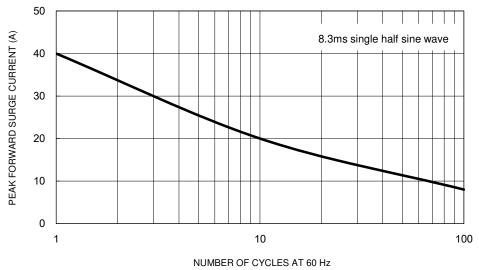
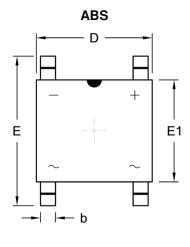


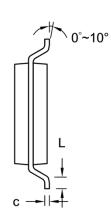
Fig.5 Maximum Non-Repetitive Forward Surge Current



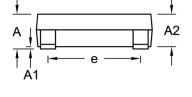


PACKAGE OUTLINE DIMENSIONS

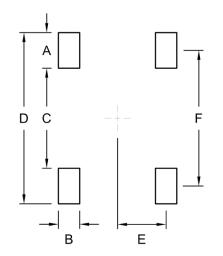




DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	1.40	1.60	0.055	0.063
A1	0.05	0.15	0.002	0.006
A2	1.35	1.45	0.053	0.057
b	0.60	0.70	0.024	0.028
с	0.15	0.25	0.006	0.010
D	4.90	5.10	0.193	0.201
E	6.25	6.65	0.246	0.262
E1	4.30	4.50	0.169	0.177
е	3.90	4.10	0.154	0.161
L	0.30	0.70	0.012	0.028

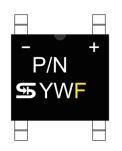


SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	1.50	0.059
В	0.90	0.035
С	4.22	0.166
D	7.22	0.284
E	2.05	0.081
F	5.72	0.225

MARKING DIAGRAM



- P/N = Marking Code
- = Date Code YW
- F = Factory Code



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